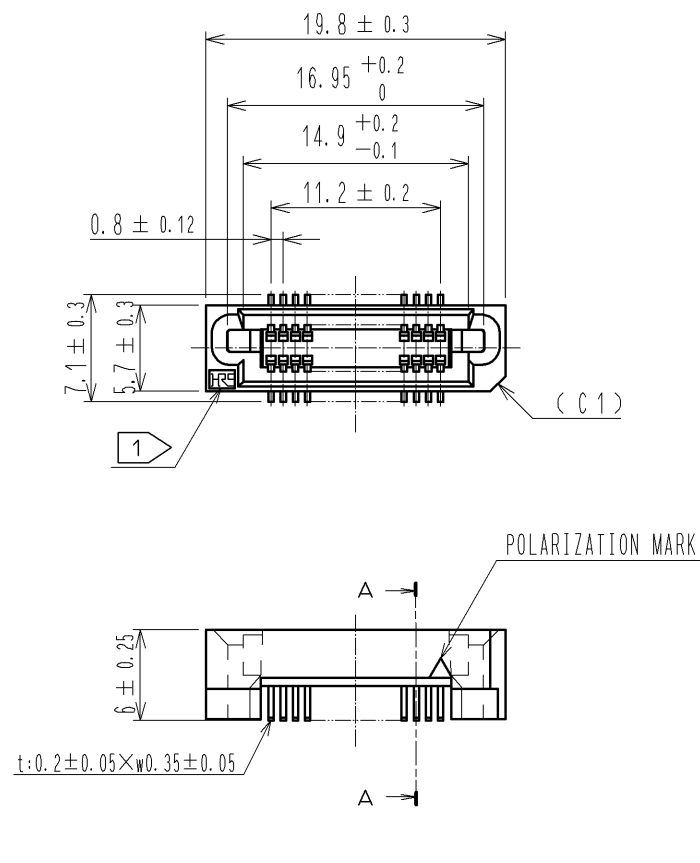
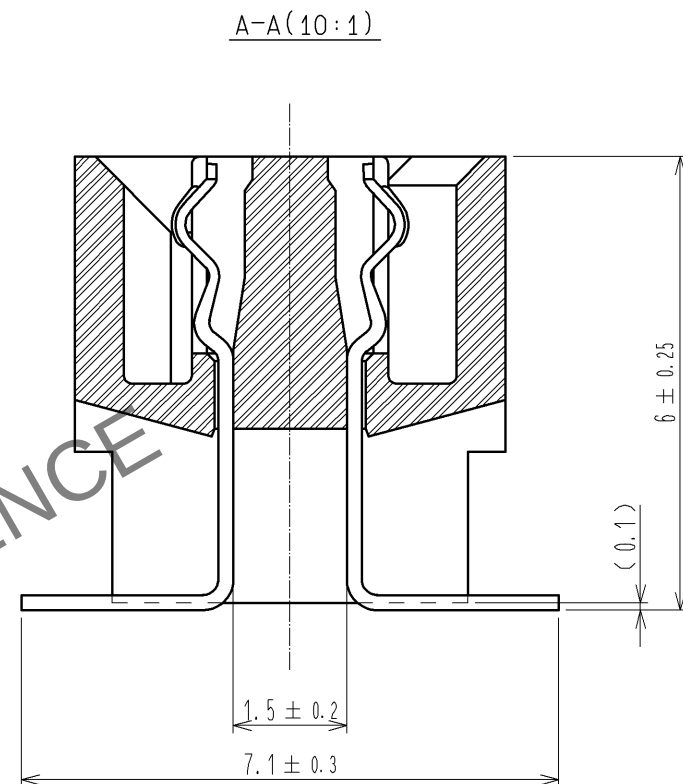
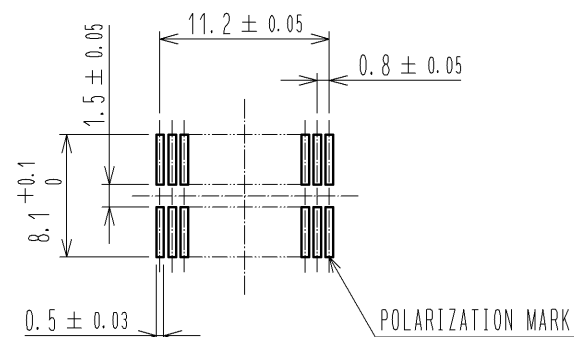


RECOMMENDED LAND PATTERN DIMENSION OF PCB (MOUNTING SIDE)
(METAL MASK THICKNESS: t=0.15)



- NOTE
- 1 HRS MARK SHALL BE OPTIONAL.
 - 2 LEAD CO-PLANARITY SHALL BE 0.1mm MAX.
 - 3 EMBOSSED CARRIER TAPE PACKAGING SHALL BE APPLIED TO THIS PRODUCT. SEE NEXT PAGE FOR DETAILS.
 - 4 THIS PRODUCT HAS TAPE FOR VACUUM PICKUP. SEE NEXT PAGE FOR DETAIL OF STICKING POSITION, ETC.
 - 5 FOR MODIFICATION, ETC. PREVENTIVE HOLE FOR SINK MARK MAY BE ADDED ACCORDING TO CIRCUMSTANCES.
 - 6 THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.
 - 7 1 REEL : 1000 CONNECTORS.
 - 8 REMOVE THE VACUUM PICKUP TAPE AFTER MOUNTING THE CONNECTOR.

2	PHOSPHOR BRONZE	CONTACT AREA: GOLD 0.1 μm min.	5	POLYIMIDE	(TAPE FOR VACUUM PICKUP)
		LEAD AREA: TIN-PLATING 1 μm min.			(COVER TAPE)
		UNDER PLATING: NICKEL 2 μm min.			(EMBOSSED CARRIER TAPE)
1	PPS	LIGHT BROWN (UL94V-0)	3	POLYSTYRENE	
NO.	MATERIAL	FINISH, REMARKS	NO.	MATERIAL	FINISH, REMARKS
UNITS mm		SCALE 2 : 1	COUNT △	DESCRIPTION OF REVISIONS	
HIROSE ELECTRIC CO., LTD.		APPROVED : HS. OKAWA	13. 08. 28	DRAWING NO. EDC3-156320-02	
		CHECKED : HT. YAMAGUCHI	13. 08. 27	PART NO. FX6A-30S-0.8SV2(93)	
		DESIGNED : TH. SANO	13. 08. 27	CODE NO. CL576-0322-7-93	
		DRAWN : TH. SANO	13. 08. 27		
		DESIGNED : HS. OKAWA	13. 08. 28		
		CHECKED : HT. YAMAGUCHI	13. 08. 27		
		DESIGNED : TH. SANO	13. 08. 27		
		DRAWN : TH. SANO	13. 08. 27		

